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Kind regards,

Team Nexperia

NPN resistor-equipped transistors; $R1 = 2.2 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$ Rev. 04 — 16 November 2009Product data sh

Product data sheet

Product profile 1.

1.1 General description

NPN Resistor-Equipped Transistors (RET) family.

Table 1. **Product overview**

Type number	Package	Package			
	NXP	JEITA	JEDEC		
PDTC123YE	SOT416	SC-75	-	PDTA123YE	
PDTC123YK	SOT346	SC-59A	TO-236	PDTA123YK	
PDTC123YM	SOT883	SC-101	-	PDTA123YM	
PDTC123YS ^[1]	SOT54	SC-43A	TO-92	PDTA123YS	
PDTC123YT	SOT23	-	TO-236AB	PDTA123YT	
PDTC123YU	SOT323	SC-70	-	PDTA123YU	

Reduces component count

Circuit drivers

Reduces pick and place costs

[1] Also available in SOT54A and SOT54 variant packages (see Section 2).

1.2 Features

- Built-in bias resistors
- Simplifies circuit design

1.3 Applications

- General-purpose switching and amplification
- Inverter and interface circuits

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	50	V
I _O	output current (DC)		-	-	100	mA
R1	bias resistor 1 (input)		1.54	2.2	2.86	kΩ
R2/R1	bias resistor ratio		3.6	4.5	5.5	



2. Pinning information

Pin	Description	Simplified outline	Symbol
SOT54			
1	input (base)		
2	output (collector)		
3	GND (emitter)		1 R1 R2 006aaa 145
SOT54A			
1	input (base)		
2	output (collector)		
3	GND (emitter)	1 2 3 001aab348	1 R1 R2 R2 006aaa145
SOT54 va			
1	input (base)		
2	output (collector)		R1
3	GND (emitter)	Ch Ch Ch Ch Ch Ch Ch Ch Ch Ch Ch Ch Ch C	1 R2 006aaa 145
SOT23; S	OT323; SOT346; SOT416		
1	input (base)	_	
2	GND (emitter)	3	
3	output (collector)	1 2 006aaa144	1 R1 R2 sym007
SOT883			
1	input (base)		
2	GND (emitter)		
3	output (collector)	2 Transparent top view	

PDTC123Y_SER_4
Product data sheet

NPN resistor-equipped transistors; $R1 = 2.2 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$

3. Ordering information

Type number	Package		
	Name	Description	Version
PDTC123YE	SC-75	plastic surface mounted package; 3 leads	SOT416
PDTC123YK	SC-59A	plastic surface mounted package; 3 leads	SOT346
PDTC123YM	SC-101	leadless ultra small plastic package; 3 solder lands; body 1.0 \times 0.6 \times 0.5 mm	SOT883
PDTC123YS ^[1]	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54
PDTC123YT	-	plastic surface mounted package; 3 leads	SOT23
PDTC123YU	SC-70	plastic surface mounted package; 3 leads	SOT323

[1] Also available in SOT54A and SOT54 variant packages (see <u>Section 2</u> and <u>Section 9</u>).

4. Marking

Table 5. Marking codes	
Type number	Marking code ^[1]
PDTC123YE	19
PDTC123YK	31
PDTC123YM	G7
PDTC123YS	TC123Y
PDTC123YT	*AL
PDTC123YU	*19

[1] * = -: made in Hong Kong

* = p: made in Hong Kong

* = t: made in Malaysia

* = W: made in China

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5. Limiting values

Table 6. In accordar	Limiting values	ım Rating System	(IEC 601	34).		
Symbol	Parameter	Conditions	I	Min	Мах	Unit
V _{CBO}	collector-base voltage	open emitter	-		50	V
V _{CEO}	collector-emitter voltage	open base	-		50	V
V _{EBO}	emitter-base voltage	open collector	-	•	5	V
VI	input voltage					
	positive		-	•	+12	V
	negative		-	•	-5	V
lo	output current (DC)		-	•	100	mA
I _{CM}	peak collector current	single pulse; $t_p \leq 1ms$	-		100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$				
	SOT416		<u>[1]</u> _		150	mW
	SOT346		<u>[1]</u> _		250	mW
	SOT883		[2][3]		250	mW
	SOT54		<u>[1]</u>		500	mW
	SOT23		<u>[1]</u>		250	mW
	SOT323		<u>[1]</u>		200	mW
T _{stg}	storage temperature		-	-65	+150	°C
Tj	junction temperature		-		150	°C
T _{amb}	ambient temperature		-	-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 60 µm copper strip line, standard footprint.

6. Thermal characteristics

Table 7.	Thermal characteristics	5				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air				
	SOT416		<u>[1]</u> _	-	833	K/W
	SOT346		<u>[1]</u> _	-	500	K/W
	SOT883		[2][3]	-	500	K/W
	SOT54		<u>[1]</u> _	-	250	K/W
	SOT23		<u>[1]</u> _	-	500	K/W
	SOT323		<u>[1]</u> _	-	625	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 60 µm copper strip line, standard footprint.

PDTC123Y_SER_4

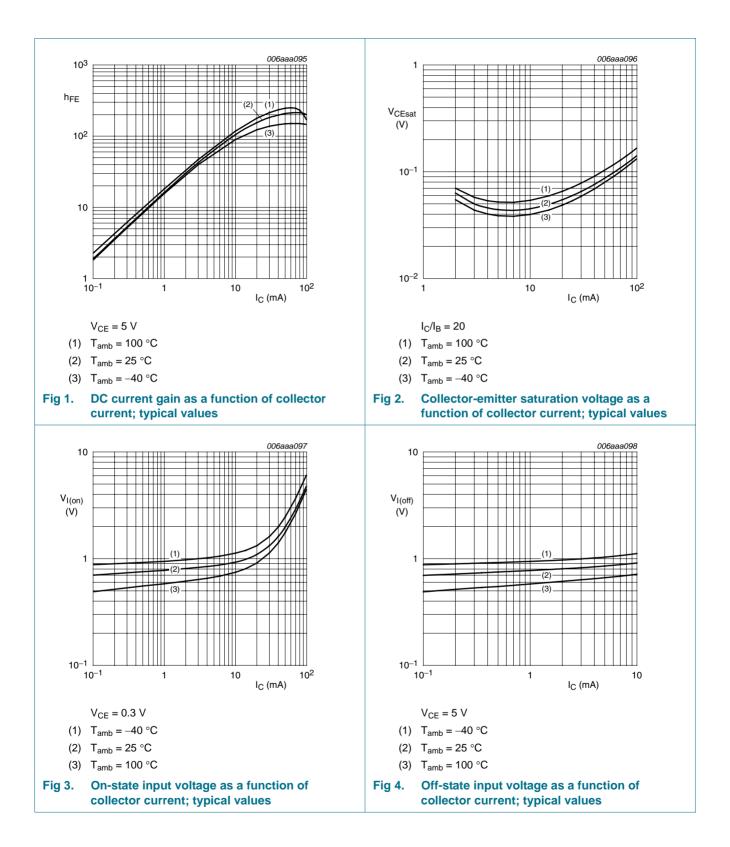
Product data sheet

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7. Characteristics

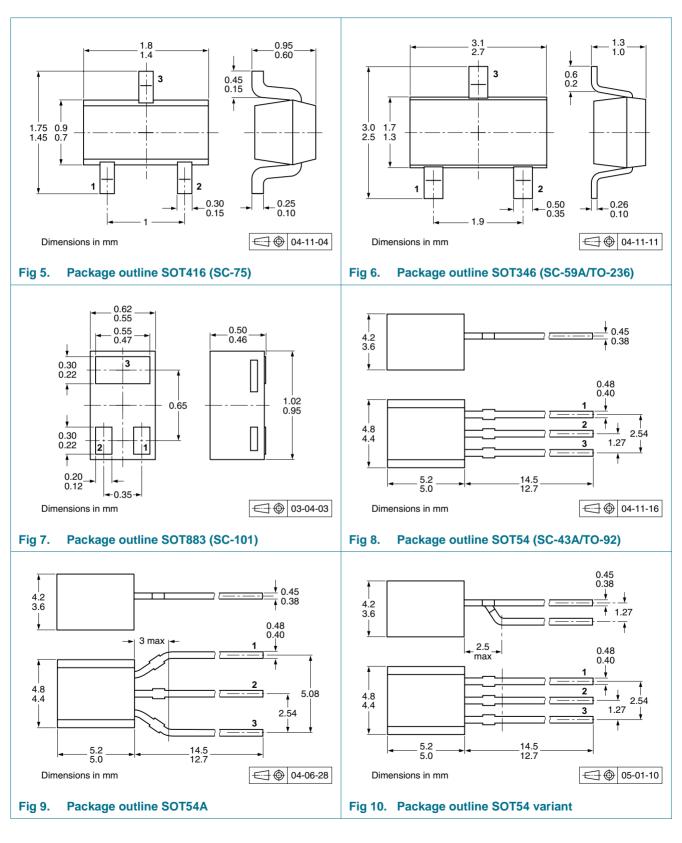
Table 8. **Characteristics** $T_{amb} = 25 \ ^{\circ}C$ unless otherwise specified. Symbol Parameter Conditions Min Тур Max Unit collector-base cut-off $V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$ 100 nA I_{CBO} -_ current $V_{CE} = 30 \text{ V}; I_{B} = 0 \text{ A}$ collector-emitter 1 μA ICEO -cut-off current $V_{CF} = 30 \text{ V}; I_{B} = 0 \text{ A};$ 50 -_ μΑ T_i = 150 °C $V_{EB} = 5 V; I_{C} = 0 A$ 700 emitter-base cut-off I_{EBO} μΑ -current DC current gain $V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ mA}$ 35 h_{FE} -- $I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$ V_{CEsat} collector-emitter -_ 150 mV saturation voltage $V_{CF} = 5 V; I_{C} = 100 \mu A$ V V_{I(off)} off-state input voltage -0.75 0.3 $V_{CE} = 300 \text{ mV}; I_{C} = 20 \text{ mA}$ V on-state input voltage 2.5 1.15 V_{I(on)} -R1 bias resistor 1 (input) 1.54 2.2 2.86 kΩ R2/R1 bias resistor ratio 3.6 4.5 5.5 C_{c} $V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ 2 pF collector capacitance -f = 1 MHz

NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 10 k Ω



NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 10 k Ω

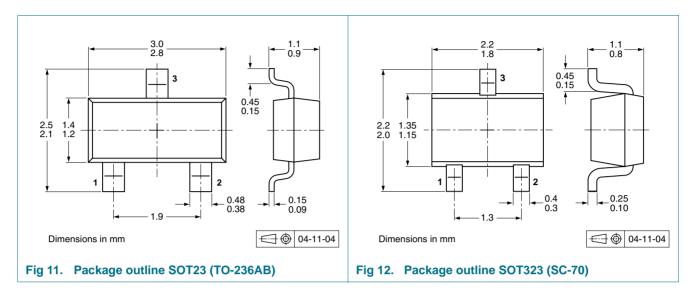
8. Package outline



PDTC123Y_SER_4

Product data sheet

NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 10 k Ω



9. Packing information

Table 9.Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	Packing quantity			
			3000	5000	10000		
PDTC123YE	SOT416	4 mm pitch, 8 mm tape and reel	-115	-	-135		
PDTC123YK	SOT346	4 mm pitch, 8 mm tape and reel	-115	-	-135		
PDTC123YM	SOT883	2 mm pitch, 8 mm tape and reel	-	-	-315		
PDTC123YS	SOT54	bulk, straight leads	-	-412	-		
	SOT54A	tape and reel, wide pitch	-	-	-116		
		tape ammopack, wide pitch	-	-	-126		
	SOT54 variant	bulk, delta pinning	-	-112	-		
PDTC123YT	SOT23	4 mm pitch, 8 mm tape and reel	-215	-	-235		
PDTC123YU	SOT323	4 mm pitch, 8 mm tape and reel	-115	-	-135		

[1] For further information and the availability of packing methods, see Section 12.

10. Revision history

Table 10. Revision his	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PDTC123Y_SER_4	20091116	Product data sheet	-	PDTC123Y_SER_3
Modifications:		eet was changed to reflect v legal definitions and discl		
PDTC123Y_SER_3	20050324	Product data sheet	-	PDTC123YT_2
PDTC123YT_2	20040510	Objective data sheet	-	PDTC123YT_1
PDTC123YT_1	20040406	Objective data sheet	-	-

11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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NPN resistor-equipped transistors; R1 = 2.2 k Ω , R2 = 10 k Ω

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